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Three-dimensional hierarchical semi-polar GaN/InGaN MQW coaxial nanowires on a patterned Si nanowire template†

Muhammad Ali Johar,[†] Taeyun Kim,[‡] Hyun-Gyu Song,^b Aadil Waseem,^a Jin-Ho Kang,^{ac} Mostafa Afifi Hassan,^a Indrajit V. Bagal,^a Yong-Hoon Cho^b and Sang-Wan Ryu^{*,a}

We have demonstrated for the first time the hybrid development of next-generation 3-D hierarchical GaN/InGaN multiple-quantum-well nanowires on a patterned Si nanowire-template. The patterned Si nanowire-template is fabricated using metal-assisted chemical-etching, and the conformal growth of the GaN/InGaN multiple-quantum-well (MQW) coaxial nanowires is conducted using metal-organic-chemical-vapor-deposition by the two-step growth approach of vapor-liquid-solid for the GaN core and vapor-solid for the GaN/InGaN MQW shells. The growth directions of the GaN nanowires are confirmed by transmission electron microscopy and selected area electron diffraction patterns. The emission of the GaN/InGaN MQW nanowire is tuned from 440 nm to 505 nm by increasing the InGaN quantum-well thickness. The carrier dynamics were evaluated by performing temperature-dependent time-resolved photoluminescence measurement, and the radiative lifetime of photogenerated electron-hole pairs was found to range from 30 to 35 ps. A very high IQE of 56% was measured due to the suppressed quantum-confined Stark effect which was enabled by the semi-polar growth facet of the GaN/InGaN MQWs. The demonstration of the growth of the hybrid 3-D hierarchical GaN/InGaN MQW nanowires provides a seamless platform for a broad range of multifunctional optical and electronic applications.

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1. Introduction

One-dimensional semiconductor nanostructures have demonstrated their importance in the implementation of novel material properties based on quantum size effects and in the development of advanced devices.^{1–3} Nanowires (NWs) are currently being studied in a variety of fields including the fields of optical,⁴ electronic,⁵ sensing,⁶ and energy applications.^{7–9} To fully exploit all of the potential advantages of NWs, a variety of approaches for the fabrication and characterization of multi-dimensional composite NWs have been used.^{10–12} These methods provide opportunities to integrate diverse materials into hierarchical NWs and enable the optimization of the structures in terms of the materials. In this regard, hierarchical NWs based on InGaN/Si, ZnO/Si, and TiO₂/Si have been fabricated and characterized.^{13–15} However, to date, most studies

have focused on the growth, fabrication, and fundamental characterization, with several publications on photo-electrochemical applications of these NWs due to their greatly increased surface area.^{16–19} Optical devices are another intriguing application because the three-dimensional (3-D) morphology offers an opportunity for controlling the light absorption and emission behavior. However, there have been no reports on the optical characteristics of hierarchical NWs. Investigation of the optical properties of such NWs would provide the basis for designing high-performance optical devices such as light emitters and solar cells.

GaN is the most important compound semiconductor material due to its wide application in light emitting diodes at ultraviolet and visible wavelengths,^{20,21} high-power electronic devices,²² and energy-harvesting applications.²³ Additionally, InGaN is used as an active medium in light emitting devices and plays an essential role in solar energy harvesters. Therefore, GaN-based NWs obtained by various growth techniques have been actively studied with the incorporation of the InGaN medium into the NWs as a critical issue. As a result, several interesting structures such as InGaN/GaN axial NWs, InGaN/GaN core-shell NWs, and InGaN/GaN multiple quantum wells (MQWs) on GaN core NWs were reported.^{24–26} The morphology of these NWs controls their optical properties, structural stability, and manufacturability. From this perspective, InGaN/

^aDepartment of Physics, Chonnam National University, Gwangju 61186, Republic of Korea. E-mail: sangwan@chonnam.ac.kr

^bDepartment of Physics, Korea Advanced Institute of Science and Technology, Daejeon 34141, Republic of Korea

^cDepartment of Electrical Engineering, Yale University, New Haven, CT, USA

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‡ M. A. Johar and T. Kim contributed equally.



GaN hierarchical NWs could offer enhanced research space for advanced optical properties owing to their complicated NW morphology.

The fundamental advantage of a high aspect ratio for the NW-based structure can be harvested from the core/shell geometry which leads to enhanced carrier collection efficiency. For the core/shell structure, the nonpolar growth of the GaN core NW is the best option because the inherent problem of long-wavelength emitters can be addressed by suppressing the quantum-confined Stark effect (QCSE). QCSE can be suppressed by growing the GaN/InGaN MQWs on either a nonpolar growth facet or a semi-polar growth facet such as (11 $\bar{2}$ 2) and (20 $\bar{2}$ 1), and additionally, the semi-polar growth facet may accommodate more indium incorporation than the nonpolar and polar surfaces.^{27,28} Therefore, the semi-polar growth of GaN/InGaN MQWs is the most preferred and is currently actively studied for GaN-based optical applications in leading laboratories.^{29–34}

In this work, we fabricate the next-generation 3-D semi-polar GaN/InGaN hierarchical NWs grown on a Si NW-template and characterize their optical properties. The morphology of the Si NWs is controlled with metal-assisted-chemical-etching (MACE) together with the morphology of the GaN NWs grown by metal-organic chemical vapor deposition (MOCVD). Reduced reflectivity is observed for the hierarchical GaN NWs on Si and the emission is tuned from the blue to the nearly green region of the solar spectrum. The hierarchical GaN NWs are used as a template for the growth of

the InGaN/GaN core-shell quantum well (QW) structures. Finally, the optical emission characteristics and temperature-dependent time-resolved photoluminescence were studied for InGaN/GaN QWs, and their applicability in optical devices was investigated.

2. Experimental procedure

2.1. Fabrication of patterned Si NWs

Fig. 1 illustrates the fabrication flow of vertically arrayed Si NWs from a highly doped p-type (100) Si wafer (resistivity < 0.005 Ω cm) by MACE. To fabricate patterned Si NWs, circular patterns with a diameter and spacing of 1 μ m were formed by photolithography (photoresist: AZ GXR601 diluted using AZ 1500 thinner with 1 : 1 ratio, developer: AZ 500 MIF). A Au thin film was used for the MACE and a 40 nm-thick Au thin film was deposited by e-beam evaporation. The MACE was performed in an HF/H₂O₂/ethanol (volume ratio 2 : 1 : 1) solution at room temperature while the Si NW length varied with etching time. Then, the Au film was removed for subsequent processing using a gold etchant. Residual Au was removed by dipping in an HF/EtOH solution (volume ratio = 1 : 20) for 60 seconds, and the dipping also removed the native oxide layer from the surface of the Si NWs. Additionally, the diameter of the Si NWs was controlled by the combination of wet thermal oxidation at 1000 $^{\circ}$ C and selective thermal oxide removal by buffered oxide etching.

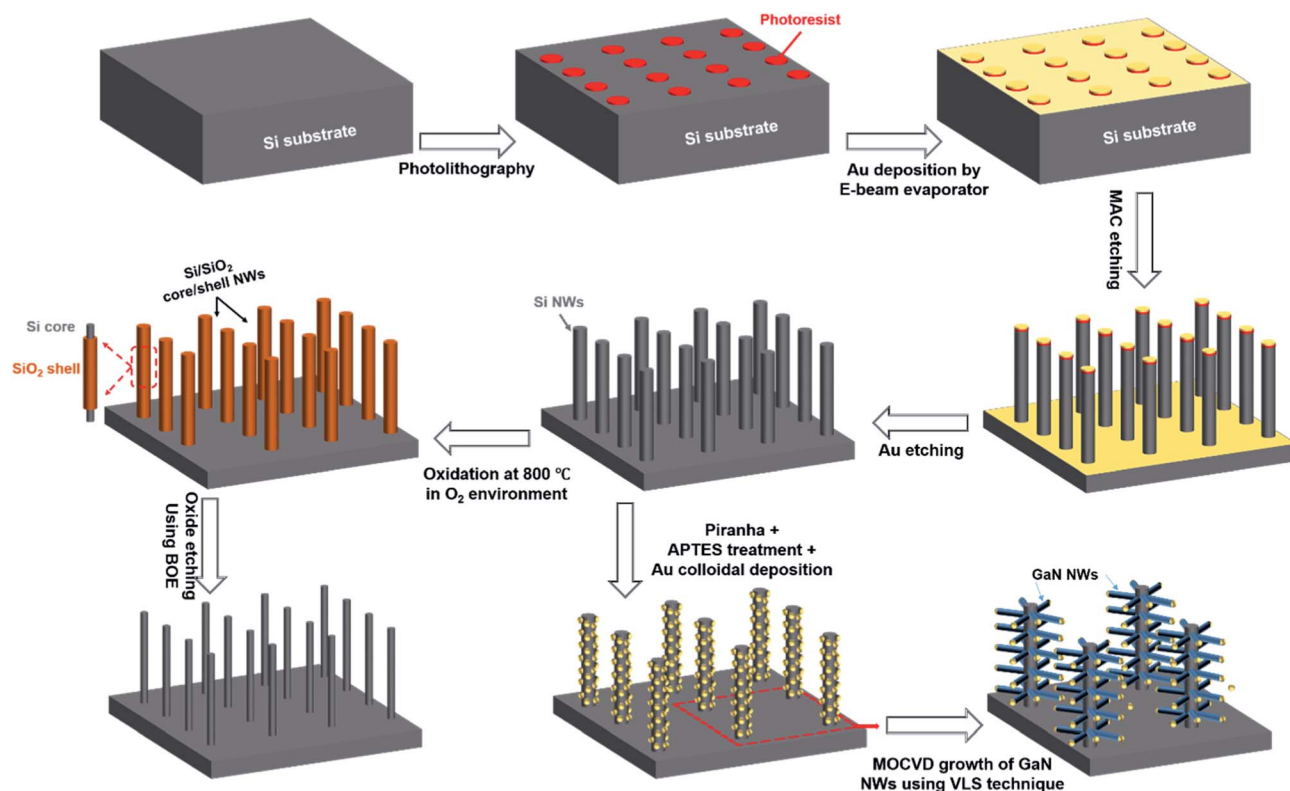


Fig. 1 Schematic illustration of the process flow for the fabrication of the GaN/InGaN/Si hierarchical NWs and the diameter control of the Si NWs.



2.2. Agglomeration of Au NPs on the Si NW-template

To grow GaN-based hierarchical NWs on the Si NW-template, the vapor-liquid-solid (VLS) growth technique was adopted using MOCVD. The metal catalyst required for the VLS growth is an important parameter that can control the density and dimensions of GaN NWs. Since vertically aligned Si NWs were used as the substrate, it was difficult to conformally deposit the metal shell on the sidewalls of the Si NWs with e-beam. Therefore, gold nanoparticles (NPs) were directly coated on the sidewalls of the Si NWs using a Au colloid solution (diameter = 14 nm). As the Au colloid NPs have negatively charged surfaces in order to prevent their aggregation, the Si NW substrate must undergo silanization treatment to create a positive charge prior to the coating. The samples underwent piranha treatment ($\text{H}_2\text{SO}_4 : \text{H}_2\text{O}_2 = 3 : 1$) for 10 minutes which converted the surface of the Si NWs to a hydrophilic state and removed the remaining PR mask at the top of the NWs. Subsequently, the substrate was dipped in a (3-aminopropyl) triethoxysilane solution (APTES : methanol = 1 : 20) for 2

hours, rinsed with methanol, and heated at 120 °C for 15 minutes. Subsequently, the substrate was dipped in the Au colloid to coat Au NPs around the Si NWs due to the Coulomb attraction. The density of the coated Au NPs was controlled by adjusting the mixing ratio of the Au colloid and methanol, obtaining the controlled density of GaN NWs.³⁵

2.3. Growth of GaN NWs and GaN/InGaN MQW NWs

Trimethylindium (TMIn) and trimethylgallium (TMGa) were introduced into a reactor at 550 °C and 650 °C, respectively, followed by their annealing at 850 °C for 1500 s to form a well-agglomerated Au/In/Ga metal alloy catalyst as reported in our previous study.⁷ The diameter of the Au NPs increased from 14 nm to ~50 nm, and hence, the diameter of the GaN core NWs is controlled. Then, the precursors for gallium and nitrogen were introduced into the reactor, and the flow rates of TMGa and NH_3 were 26.4 $\mu\text{mol min}^{-1}$ and 3.125 mmol min^{-1} , respectively, with a V/III ratio of 118. The carrier gas was H_2 with a flow rate of 10.4 slm. After the VLS growth of the core GaN NWs, the lateral growth

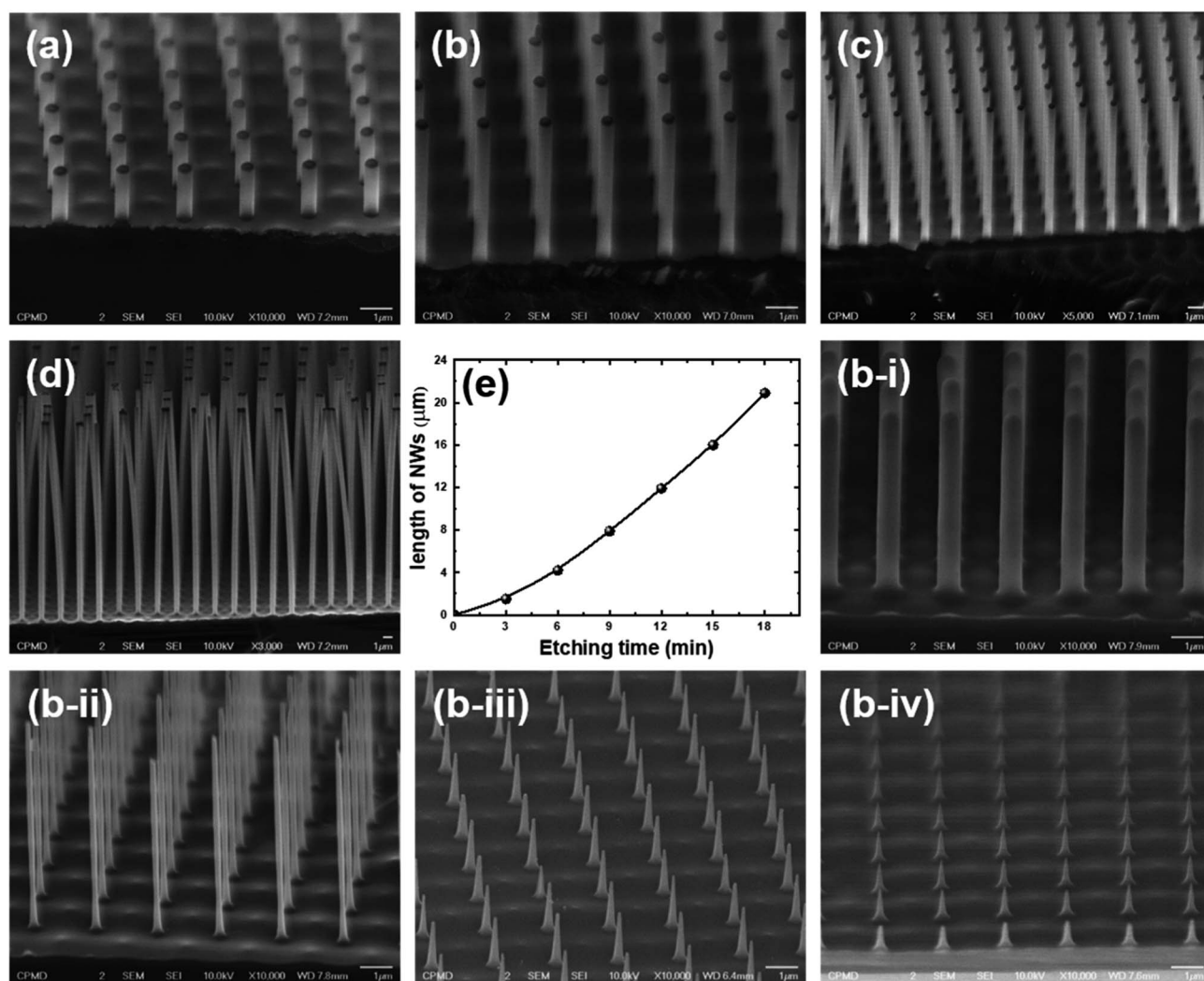


Fig. 2 Scanning electron micrographs of the Si NWs with an etching time of (a) 3 min, (b) 6 min, (c) 9 min, and (d) 18 min. (e) The effect of the etching time on the Si NW length. (b-i) Wet thermal oxidation at 1000 °C, the images shown were captured after etching the oxide shell from the Si core; (b-ii) oxidation time of 10 min; (b-iii and b-iv) oxidation time of 20 min.



of the GaN shell was initiated by increasing the V/III ratio to 20 000 using the vapor–solid (VS) growth mode. Then, the GaN barriers were grown laterally around the GaN shell with the TMGa and NH_3 flow rates of $21.1 \mu\text{mol min}^{-1}$ and $402 \text{ mmol min}^{-1}$, respectively. To grow InGaN QWs, the temperature was ramped down to $820 \text{ }^\circ\text{C}$ while the precursor for indium ($\text{TmIn} = 51.75 \mu\text{mol min}^{-1}$) was also introduced. The growth time for the InGaN QWs was increased to 55 s, 110 s, and 165 s for samples (A), (B), and (C), respectively, while the total number of InGaN/GaN pairs was also optimized.

2.4. Structural and optical characterization

The patterning for the fabrication of Si NWs was conducted using a photolithography mask aligner (MDA 400 S UV). The dry etching was performed by inductively coupled plasma-reactive ion etching (VSICP 12 RC system). The Au film was deposited using an electron beam evaporator (World Vacuum, HVE-500A). The GaN/InGaN MQW NWs on the Si NWs were grown in a showerhead-based metal organic chemical vapor deposition system (CCS-FT 19×2 inch, Aixtron). The morphology of the Si NWs and GaN/InGaN MQW NWs was initially examined using a field emission scanning electron microscope (FE-SEM, JSM-6700F, Jeol). In-depth morphological analysis was conducted and the growth direction of GaN NWs was determined using a transmission electron microscope (JEM-2100F, Jeol). The reflectance was measured using

a UV-vis spectrophotometer (Lambda 950 spectrometer, PerkinElmer). The room temperature PL spectrum of the 3-D hierarchical GaN/InGaN MQW NWs grown on the Si NW-template was recorded using a spectrometer ($f = 0.5 \text{ m}$, Acton Research Co. spectrograph 500i), and an intensified CCD camera (P1-Max3) (Princeton Instrument) with a diode-pumped solid-state laser (Ekspla) with an excitation wavelength of 266 nm and a power of 11 mW. To measure the lifetime of photogenerated electron–hole pairs, TRPL study was carried out at a low temperature. The TRPL study was conducted with a 375 nm continuous-wave laser diode on the macroscale to deduce the PL efficiency. The temperatures of the samples were controlled from 18 K to 300 K in a closed helium cycle cryostat system. The TRPL spectra were measured with the second harmonic generation of a mode-locked Ti:sapphire laser (Coherent, Cameleon Ultra II) and a streak camera (Hamamatsu, C7700-01) for the examination of the temperature-dependent carrier dynamics. The pulse width, wavelength, and repetition rate of the pulsed laser were 200 fs, 375 nm, and 2 MHz, respectively. The temporal resolution of the time-resolved PL system was approximately 6 ps.

3. Results and discussion

3.1. Growth and morphology evolution

Fig. 1 shows the schematics of the fabrication flow of the 3-D GaN-based hierarchical NWs grown on a Si NW-template. The Si

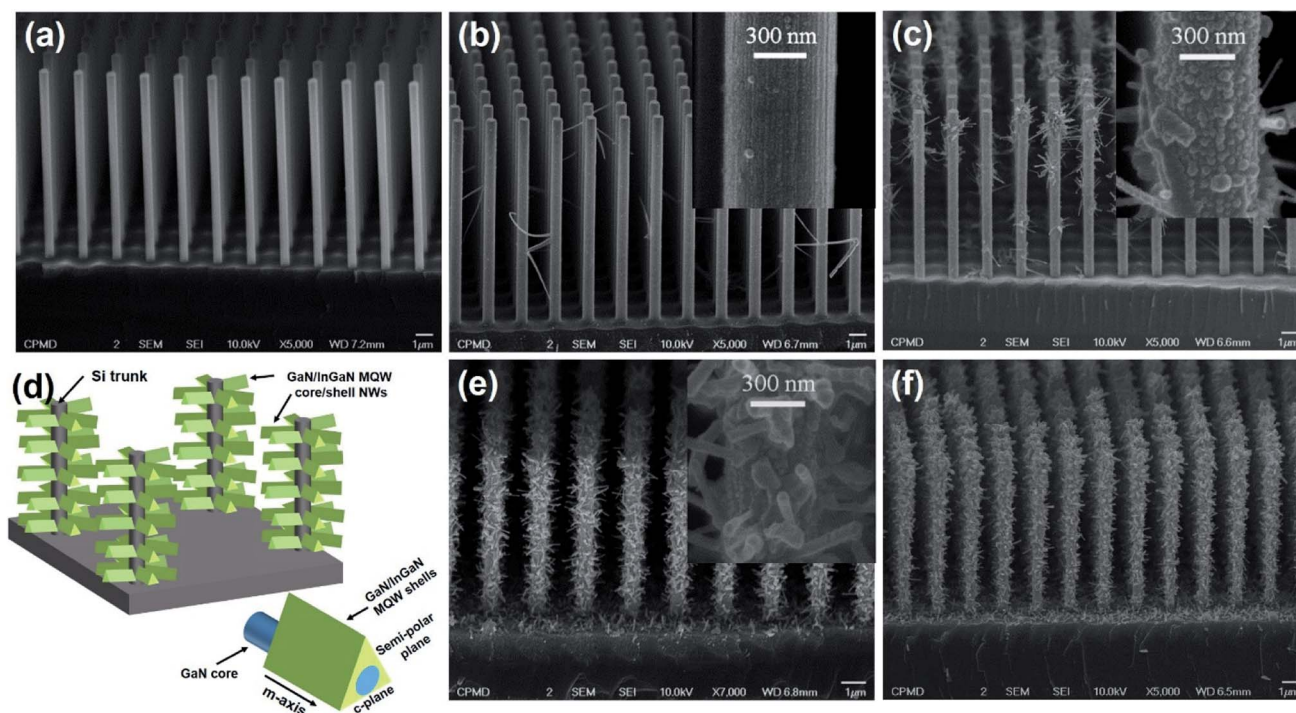


Fig. 3 Optimization process for the Au colloid deposition and GaN-based NW-growth. (a) Scanning electron micrograph of the bare Si NWs and growth of the GaN NWs on the Si NW-template using Au NPs; the NPs were deposited (b) without the APTES treatment (the inset shows agglomerated NPs) and (c) with the APTES treatment but without indium and gallium deposition while the inset shows the agglomeration of the NPs and NW-growth. (d) Schematic illustration of the InGaN/GaN MQW NW shells around the GaN core NWs and the inset shows the cross-sectional view of the GaN core (circular) and the GaN/InGaN MQW shells (triangular shaped), (e) both APTES and In/Ga are used and the inset shows the NWs grown from the agglomerated NPs, and (f) growth of the GaN/InGaN/Si 3-D hierarchical NWs over a large area.



NWs were fabricated by photolithography and MACE (using Au as the metal).³⁶ Following the top-down growth of the Si NWs, their diameter was reduced by oxidization at 1000 °C for a controlled time which gave rise to the core/shell structure of the Si/SiO₂ NWs. The SiO₂ shell was etched using a buffer oxide etching solution. To grow GaN NWs on the Si NW-template, piranha and APTES treatment of the NWs was conducted. The piranha removed the organic residue while the APTES treatment generated positive polarity on the surface of the Si NWs. Colloidal Au (with negative charge) was attached to the Si NWs due to the attractive Coulomb force. The colloidal Au acted as a catalyst to facilitate the vapor-liquid-solid (VLS) growth of the GaN NWs.

The length of the Si NWs was optimized by controlling the MACE time as shown in Fig. 2. Fig. 2(a-d) show the increased length of the Si NWs for the MACE times of 180, 360, 540, and 1200 s, respectively. The length of the Si NWs increased from 1.8 to 22 μm. The effect of MACE on the NW length is illustrated in greater detail in Fig. 2(e). To reduce their diameter, the Si NWs were oxidized, resulting in an increased diameter of the NWs with the Si/SiO₂ core/shell structure as shown in Fig. 2(b-i). The shell was etched using a buffer oxide etching solution, and finally, the Si NWs were fabricated with a reduced diameter of less than 200 nm. To reduce the diameter, the samples were oxidized for 600 s and 1200 s as shown in Fig. 2(b-ii and b-iii), respectively. The minimum possible diameter is determined by the mechanical stability of the NWs, *i.e.* the NWs are broken or damaged when the diameter is very small. The criterion depends not only on diameter but height also plays a key role. Therefore, we can achieve a diameter thinner than 200 nm if we use shorter NWs as shown in Fig. 2(b-ii). As the oxidation time increases from a particular limit, all of the NWs transform to SiO₂, and hence the top side is fully etched and the NWs evolve into a tapered shape as shown in Fig. 2(b-iii and b-iv). Therefore, this technique provides an approach for the fabrication of a patterned structure with precision which surpasses the limitations of the conventional photolithography used for the fabrication of Si-based structures.

Following the patterned growth of the Si NWs, the surface treatment of the Si NWs was carried out in order to deposit Au NPs. To elucidate the role of the surface treatment, the GaN NWs were grown with and without the APTES treatment. Fig. 3(a) shows the scanning electron micrograph of bare Si NWs after the piranha treatment which converted the surface to a hydrophilic state. The next step in the processing was to make the surface positively charged to enable the attachment of Au NPs to the Si NWs due to Coulomb interaction. Then, the GaN NWs were grown, and Fig. 3(b and c) show the SEM images of the samples fabricated without and with APTES treatment, respectively. Regarding the attachment of Au NPs on the Si NWs, a very clear difference is observed between the insets of Fig. 3(b and c). Hence, it is demonstrated that the APTES treatment enabled the surface to be more active for the attachment of Au NPs. The density of the GaN NWs can be controlled by optimizing the ratio of the Au colloid to the methanol solution.³⁵ By reducing the melting temperature of the catalyst, the coverage of the Si NWs with GaN/InGaN MQWs

can be increased. Additionally, indium incorporation into the NWs is enhanced at lower growth temperatures. Therefore, to reduce the melting temperature of the Au NPs, *in situ* deposition of very thin films of indium and gallium was carried out. Subsequent annealing resulted in the agglomeration of the Au/In/Ga metal-alloy catalyst with a low melting temperature, and high-density growth of the GaN NWs was achieved. After the axial growth of the GaN core NWs, the growth mode was switched to lateral growth by increasing the V/III ratio. The lateral growth of the GaN changed the geometry of the GaN NWs' cross-section from circular to triangular. The smooth surface of the triangular-shaped GaN provided a high crystal quality platform for the growth of the active region of the InGaN/GaN MQW shells. A schematic diagram of the growth of the triangular-shaped MQW shells around the GaN core NWs on the Si NW-template is shown in Fig. 3(d), and the inset illustrates the growth of a single NW in more detail. The SEM photograph presented in Fig. 3(e) shows the 3-D hierarchical conformal growth of the GaN NWs on the Si NW-template using

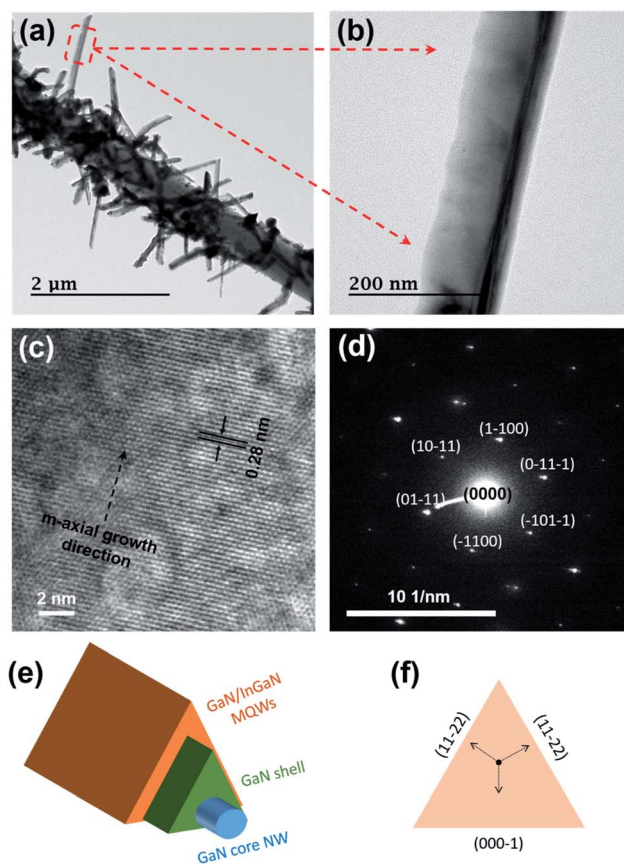


Fig. 4 Transmission electron microscopy image of the GaN/InGaN MQW NWs on the Si trunk. (a) Low-magnification TEM image, (b) high-magnification image of a single GaN/InGaN MQW NW, (c) high-resolution image of the respective NWs, depicting the interplanar spacing of the planes along the growth direction of the GaN core NWs, and (d) SAED patterns showing the growth direction of the core NWs along the *m*-axis. (e) Schematic illustration of the geometry of GaN core NWs and the triangular shells around the core and (f) the growth direction of evolved facets of triangular shells around GaN core NWs.



the Au/In/Ga metal-alloy spheres as a catalyst. It is observed from the inset that the growth of the GaN NWs started from all around the Si NW-template. Then, the InGaN/GaN MQW shells were grown and their SEM micrograph is shown in Fig. 3(f).

To evaluate the growth direction and the crystal quality of the GaN NWs, transmission electron microscopy was conducted. The 3-D hierarchical NW-structure was cut using a doctor's blade and sonicated in ethanol, and then a drop of this solution was poured onto a TEM grid. A low-resolution TEM micrograph of the 3-D hierarchical structure over a single Si NW is shown in Fig. 4(a). Several GaN NWs were separated from the Si trunk during the sonication, and therefore, high-density branches are not observed unlike in the images observed by SEM. A single GaN-based NW is presented in Fig. 4(b) in order to examine the overall surface smoothness. A high-resolution image of the same NW is presented in Fig. 4(c), showing an interplanar spacing of 0.28 nm which is ascribed to the m -axial growth direction of the GaN core NWs. To verify that the growth direction is along the m -axis, selected area electron diffraction (SAED) patterns were also measured. The SAED patterns confirm the same growth direction as shown in Fig. 4(d). The zone axis of the electron beam was the $(\bar{1}\bar{1}23)$ plane and the growth direction was toward the $[1\bar{1}00]$ plane. Here, it is very important to mention about the controlled growth direction of GaN core NWs on all host facets of the Si trunk. It was verified by conducting TEM for several samples, and all the time, the growth direction was m -axial. It is possible to optimize the growth direction of GaN NWs during VLS growth mode by controlling the catalyst composition even on a polycrystalline substrate.³⁷ A triangular cross-section of the GaN/InGaN MQW NWs is observed which is attributed to the $(11\bar{2}2)$ semi-polar growth direction of the GaN/InGaN MQW shells, with the schematics shown in Fig. 4(e and f), as it was observed in our previous publications.^{26,37} The optical properties of the active region grown on the semi-polar plane are enhanced when the

inclination angle of the polar-plane to the semi-polar growth plane ranges from 45° to 60° . For the incorporation of indium into the InGaN QWs, over a wide range of growth temperatures, the most favorable planes are $(11\bar{2}2)$ and $(10\bar{2}1)$. Among these, the surface of the $(11\bar{2}2)$ semi-polar plane exhibits the highest indium incorporation rates.³⁸ The triangular-shape evolution of the GaN/InGaN MQW coaxial NWs can be understood with the help of kinetic Wulff plots known as ν -plots. After the growth of the GaN core NWs, the lateral growth starts together with the competition between all of the planes perpendicular to the m -axis with the fast-growing planes growing to extinction while the slower-growing planes define the final shape.^{39,40} In this case, the growth rate of the (0002) plane is the slowest while the $(11\bar{2}2)$ is the second-slowest-growing plane, with the convex geometry of NWs making the slowest growing planes appear on the sidewalls of the GaN core NWs. Therefore, this is an appropriate approach for understanding the sidewall evolution of the shell growth mechanism around the GaN core NWs.

3.2. Optical properties of 3-D hierarchical GaN/InGaN/Si MQW NWs

Efficient absorption of light is vital for enhanced device applications. The high measured reflectance is one of the many parameters that may reduce the device efficiency. In this regard, suppression of the reflectance is highly important for a variety of optical applications. Therefore, the reflectance of the 3-D hierarchical GaN/InGaN MQW NWs grown on the Si NWs was measured to demonstrate the potential of this unique morphology. The reflectance was measured at the wavelengths between 350 and 800 nm. Fig. 5(a) shows the results of the reflectance measurements of the bare Si substrate, Si NW-templates with different lengths and the samples obtained after the growth of the 3-D hierarchical GaN/InGaN MQW NWs on the Si NW-template. The difference between the reflectance

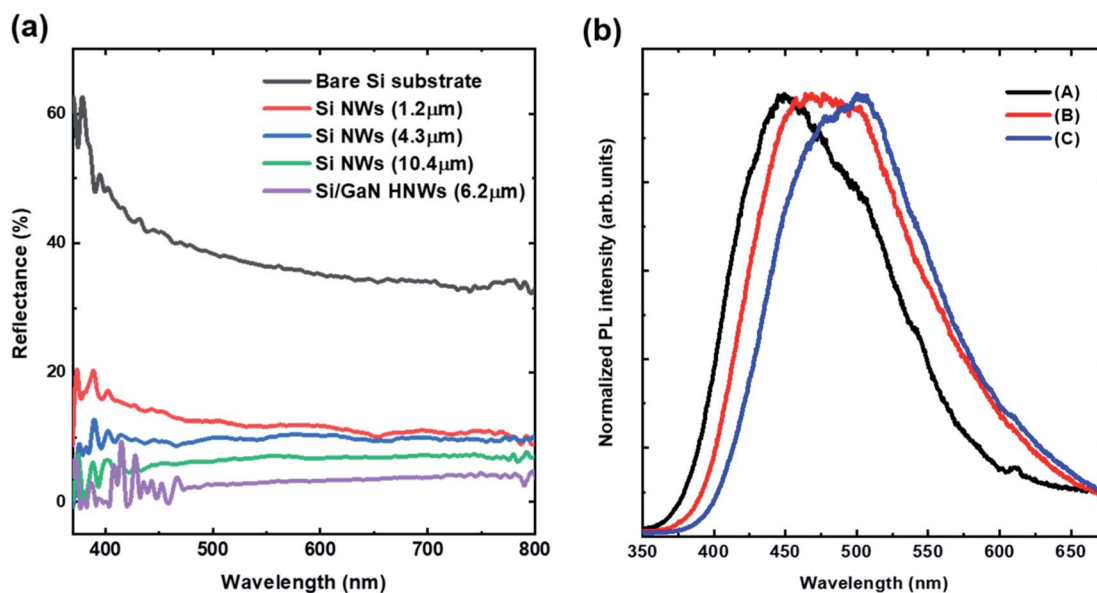


Fig. 5 (a) The effect of NWs' morphology on reflectance and (b) room temperature PL measurements.



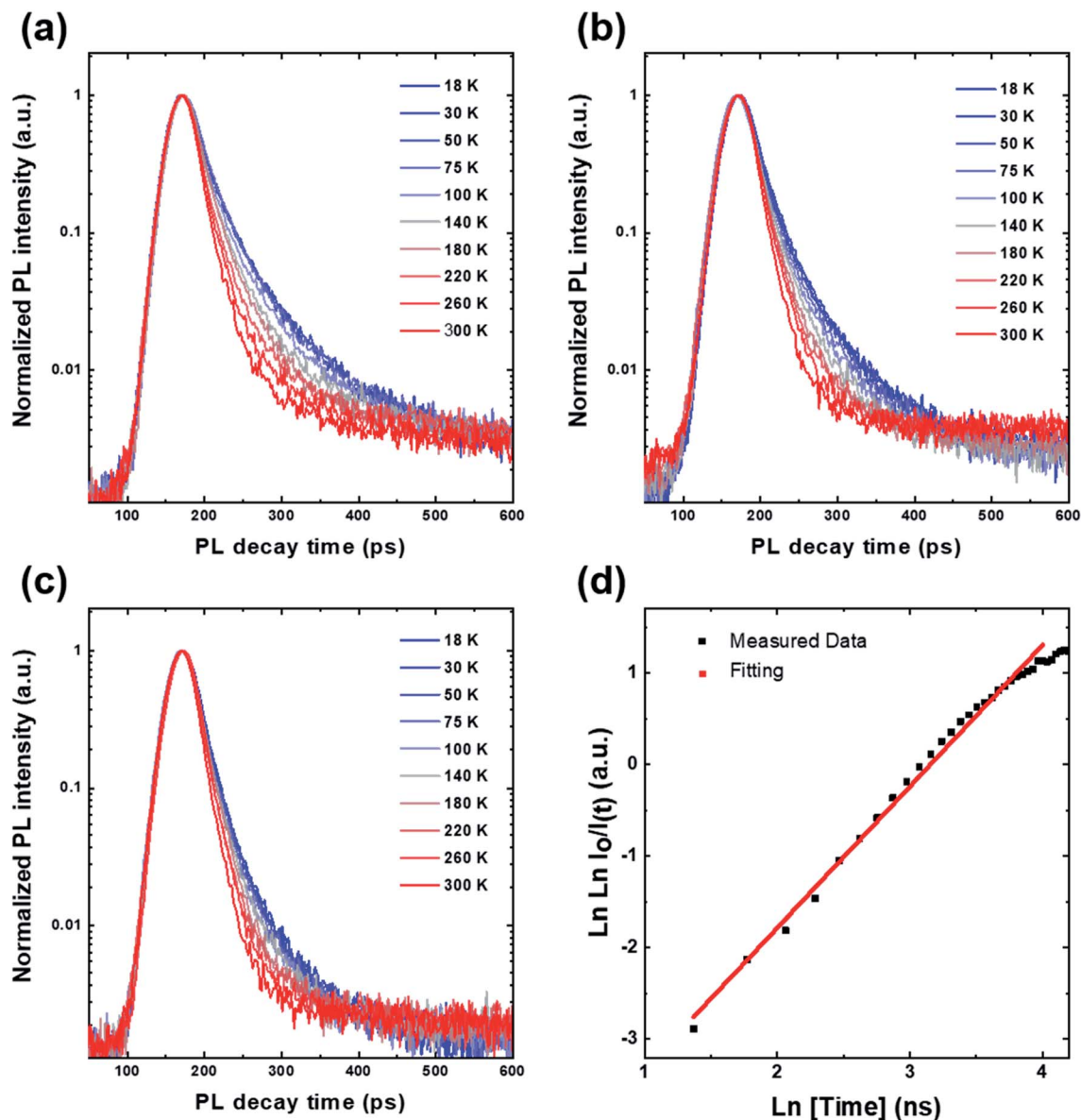


Fig. 6 Temperature-dependent TRPL of (a) sample (A), (b) sample (B), and (c) sample (C). (d) Demonstration of the fitting using the stretched exponential model on sample (A) at 18 K.

values for the bare Si substrate and the 3-D hierarchical GaN/InGa_n MQW NWs on the Si NW-template is as high as 35% for the entire visible region. Hence, the 3-D hierarchical GaN/InGa_n MQW NWs grown on the Si NW-template provide a favorable medium for efficient light absorption. Initially, the optical emission from the 3-D hierarchical GaN/InGa_n MQW

NWs grown on the Si NW-template was evaluated using room temperature PL. The excitation wavelength and optical power of the laser were 266 nm and 11 mW, respectively. To optimize the emission intensity from the active region of GaN/InGa_n MQWs, the number of QW pairs was varied as 5, 7, and 9 (the obtained emission profile is described in the ESI†), and it was found that

Table 1 Calculations of carrier lifetimes from the TRPL decay curves as a function of the QW thickness *i.e.*, the growth time of the InGa_n QWs

Sample name	QW thickness, d_{QW} (nm)	Time constant at 300 K, $\tau_{300 \text{ K}}$ (ps)	Radiative lifetime, τ_{r} (ps)	Nonradiative lifetime, τ_{nr} (ps)	IQE, (%)	Stretching constant, β
(A)	0.6	19.4	34.8	43.8	55.8	0.77
(B)	1.2	17.2	31.4	37.9	54.6	0.75
(C)	1.8	14.5	30.7	27.5	47.2	0.72



the integrated intensity increased with the number of QWs. Among these, the sample having 5 pairs of QWs was chosen for tuning the emission spectrum. To demonstrate the high crystal quality of the GaN/InGaIn MQW NWs even at longer emission wavelengths, the number of pairs with low emission intensity was fixed (5 pairs). To tune the emission profile, the InGaIn QW thickness was increased from sample (A) to sample (C) and the emission profile was measured at room temperature using PL as shown in Fig. 5(b). The central wavelength of the peaks was measured as 448 nm, 476 nm, and 503 nm for samples (A), (B), and (C), respectively. Due to quantum confinement, the emission peak shifted to longer wavelengths with increased QW thickness. Peak broadening and the characteristic yellow luminescence were not observed for all of the samples, indicating the high crystal quality of the GaN/InGaIn MQW NWs grown on the Si NW-template. Furthermore, the band-to-band transition of GaN was not observed, providing proof of the full coverage of the GaN core NWs with the GaN/InGaIn MQWs from top to bottom.

3.3. Carrier dynamics of 3-D hierarchical NWs

The carrier lifetime of the photogenerated carriers of the 3-D hierarchical semi-polar GaN/InGaIn MQW NWs grown on the Si NW-template was measured using temperature-dependent

time-resolved PL (TRPL). The excitation source was a 375 nm continuous wave laser diode while the temperature was varied in the 18–300 K range using a closed helium cycle cryostat system. The TRPL spectra were measured with the second harmonic generation of a mode-locked Ti:sapphire laser (Coherent, Cameleon Ultra II) and a streak camera (Hamamatsu, C7700-01) for low-temperature carrier dynamics. The wavelength, pulse width, and repetition rate of the pulsed laser were 375 nm, 200 fs, and 2 MHz, respectively. The temporal resolution of the time-resolved PL system was approximately 6 ps. The temperature-dependent temporal decay curves measured using TRPL of samples (A), (B), and (C) are shown in Fig. 6(a–c), respectively. The stretched exponential model given in eqn (1) provides the best method for estimating the lifetime of the carriers of a system with a non-single decay.

$$I(t) = I_0 \exp[-(t/\tau)^\beta], \quad (1)$$

where I_0 is the initial intensity, $I(t)$ is the intensity at time t , β is the stretched parameter for the localized states which ranges from zero to one, and τ is the time constant. The stretched exponential model is widely used for strongly disordered systems. In an InGaIn QW, the disorder originates from both energetic and topological disorders. The stretched parameter β ranges from zero to one and is a measure of disorder, *i.e.*, it is

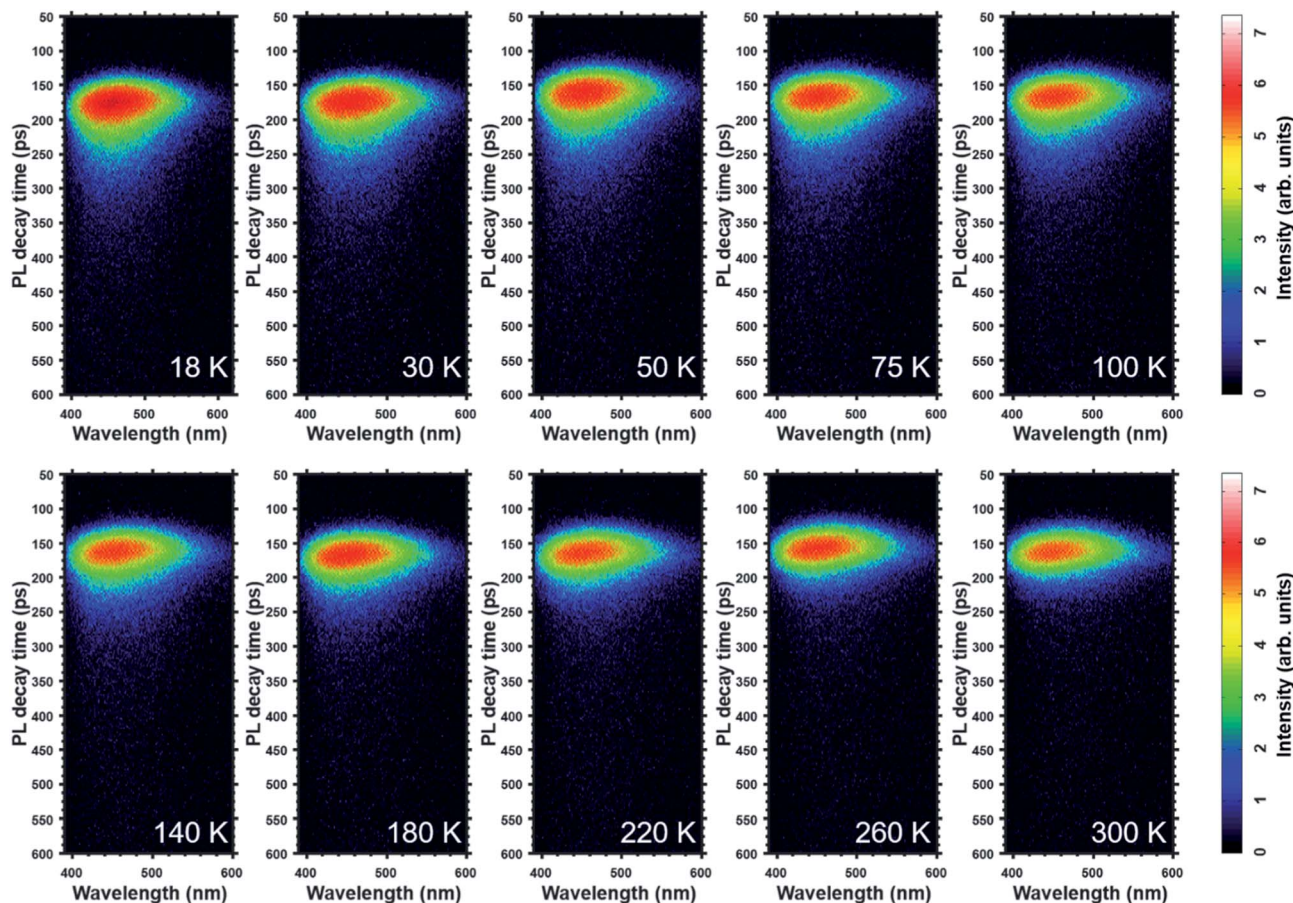


Fig. 7 Temperature-dependent temporal decay maps of sample (A).



close to one for a weakly disordered system while the lower values indicate the presence of a strong disorder in the InGaN QW. The value of β is calculated from τ using the plot of the double logarithm of the PL decay intensity *versus* the logarithm of time. The decay constant measured at 18 K was considered the radiative time constant (τ_r) by considering the freezing-out of all of the defect-related transitions at low temperatures, and the stretched exponential fitting of sample (A) measured at 18 K is shown in Fig. 6(d). The nonradiative lifetime (τ_{nr}) was calculated using the relation $1/\tau_{nr} = 1/\tau_{300\text{ K}} - 1/\tau_r$ and the internal quantum efficiency (IQE) was obtained from the relation $\text{IQE} = \tau_{nr}/(\tau_{nr} + \tau_r)$. The radiative lifetimes of samples (A), (B), and (C) are calculated as 34.8, 31.4, and 30.7 ps, respectively, exhibiting the respective IQE values of 55.8%, 54.6%, and 47.2%. The detailed analysis of τ_r , τ_{nr} , $\tau_{300\text{ K}}$, β , and IQE is described in Table 1. The radiative and nonradiative

recombination rates show a similar dependence on the QW thickness. This enhanced radiative recombination rate is typical for the InGaN QWs grown on the nonpolar and semi-polar growth planes. The overlap of the electron and hole wave functions is poor for a very thin QW and improves for the optimized QW thickness so that QCSE is suppressed for the samples with thicker QWs. The enhanced nonradiative recombination rate obtained at greater QW thickness can be explained by the strain accumulation effect; the increased QW thickness promotes fluctuations in the indium concentration, so that more strain is accumulated. Therefore, increased defect generation in the thick InGaN QWs leads to the reduced τ_{nr} , corresponding to the so-called increased nonradiative recombination rate. Another piece of evidence of increased indium concentration fluctuations is the decreased value of β which decreases with increased QW thickness. Overall, the quantum

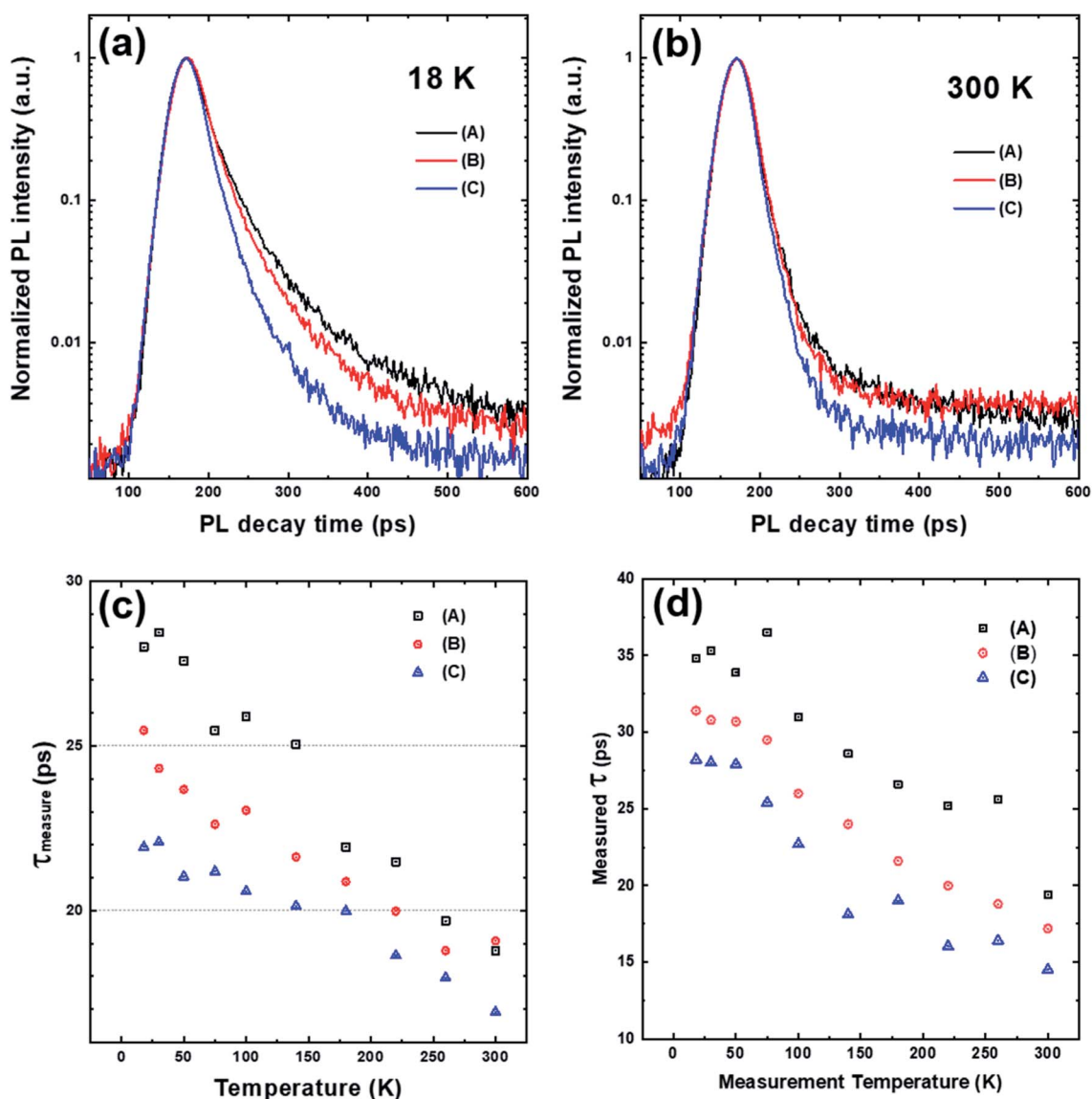


Fig. 8 TRPL measurements of all of the samples at (a) 18 K and (b) 300 K. Calculations of the time constant with the measurement temperature and QW thickness using (c) the single exponential model and (d) the stretched exponential model.



efficiency of the sample with the lower InGaN thickness is the highest. Therefore, the TDCs deduced from the temperature-dependent TRPL measurements provide an overall understanding of the quality of the hybrid structure of the 3-D hierarchical GaN/InGaN/Si MQW NWs exhibiting a range of emission wavelengths for a variety of potential applications.

To understand the overall carrier dynamics of the hybrid structure of the 3-D hierarchical GaN/InGaN MQW NWs grown on the Si NW-template, temporal decay maps (TDMs) were recorded as a function of the emission wavelength over time. The TDMs of all of the samples were recorded at 18, 30, 50, 75, 100, 140, 180, 220, 260, and 300 K. The TDMs measured at all of these temperatures are shown in Fig. 7 while the TDMs of samples (B) and (C) are described in the ESI.† A redshift in the tails of TDMs is observed with increased QW thickness while the tail shows the carriers with a long lifetime. The underlying phenomena for the redshift can be described using the model proposed by Minsky *et al.* and Chichibu *et al.*^{41,42} According to this model, the radiative recombination in InGaN QWs can occur either through free-exciton or bound-exciton transitions. For thin InGaN QWs, only the free-exciton recombination mechanism is possible while the localized states are formed due to the indium concentration fluctuations inside the thick QWs which lead to the radiative recombination through bound excitons. It is well-known that the lifetime of the radiative transitions through free excitons is longer than that through the bound- or localized-excitons. Therefore, the results of the TDMs recorded with increased QW thickness are in good agreement with the results of TDCs.

The emission wavelength-dependent PL decay rates as a function of the measurement temperature are recorded in the TDMs and shown in Fig. 7 for sample (A). The tail of the TDMs at low temperatures is more prominent than that for the room temperature measurements. The underlying reason for the shortened lifetime of the carriers at room temperature can be explained by the potential distribution of the carriers. Due to indium concentration fluctuations inside the InGaN QWs, weakly localized and strongly localized states are formed. The carrier escape and capture at low temperature are inefficient so that the carrier transport is inefficient. As the temperature increases, the carriers' escape from the weakly localized states becomes efficient and the carriers are relaxed by the strongly localized states *via* hopping. Then, as the temperature is increased further and reaches the value near room temperature, carrier thermalization occurs in strongly localized states and leads to carrier escape, so that the decay tail decreases over time as shown in the TDM measured at 300 K in Fig. 7. Hence, the results of the TDM analysis are in good agreement with our previous discussion based on the results of TDCs.

To demonstrate the broader aspect of the influence of QW thickness on carrier dynamics as a function of the measurement temperature, the TDCs measured at 18 K and 300 K are explicitly shown in Fig. 8(a and b), respectively. The decay constant was measured using a single exponential model and a stretched exponential model. The time constant obtained (18 to 300 K) using the single exponential model for samples (A), (B), and (C) varied from 28 to 19 ps, from 25 to 19 ps, and from 22 to 17 ps,

respectively, as shown in Fig. 8(c). The time constant obtained (18 to 300 K) using the stretched exponential model for samples (A), (B), and (C) varied from 35 to 19 ps, from 31 to 17 ps, and from 28 to 15 ps, respectively, as shown in Fig. 8(d). The optical results of TDCs and TDMs are in good agreement with each other, indicating the high crystal quality of the 3-D hierarchical GaN/InGaN MQW NWs for a variety of optical and electronic applications.

4. Conclusions

In summary, a facile and scalable route for the fabrication of next-generation 3-D hierarchical GaN/InGaN/Si NWs using a simple two-step growth mechanism by MOCVD on patterned Si NWs is reported. The Si NWs were fabricated by photolithography and the final diameter of the obtained Si NWs was as high as 200 nm. Then, the nonpolar [1100] GaN NWs were grown around the Si NW-trunk, and the growth axis of GaN core NWs was optimized using a controlled catalyst composition. The lateral growth of the GaN/InGaN MQW shells around the GaN core NWs was conducted by increasing the V/III ratio and their growth was carried out on the semi-polar growth facet which leads to the suppressed QCSE. The optical emission was tuned from 440 to 505 nm by increasing the InGaN QW thickness. The carrier dynamics were evaluated by conducting low-temperature TRPL measurement. An ultrashort carrier lifetime in the 28–35 ps range was measured together with an IQE of 56%. Such a high IQE is achieved due to the reduced reflectance and the semi-polar growth facet of the GaN/InGaN MQW structure. The comprehensive analysis of TDCs and TDMs confirmed the high crystal quality of the 3-D hierarchical GaN/InGaN/Si MQW NWs which enables their use in a wide range of next-generation optical and electronic applications.

Conflicts of interest

The authors declare no competing financial interest.

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